Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L1	1703	backgrind\$4 back-grind\$4 back adj grind\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/01 12:37
L2	68	L1 with (via throughole through adj hole through-hole chip near through throughchip) with (back backside)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	OŃ	2005/08/01 12:37
L3	0	L2 and (@ad < "19980601") and (paste powder)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/01 12:37
L4	3976	((438/637) or (438/640) or (438/675) or (438/977) or (438/928)).CCLS.	US-PGPUB; USPAT; USOCR	OR	OFF	2005/08/01 12:38
S19 9	5	US-4840923-\$.DID. OR US-5913146-\$.DID. OR US-6057231-\$.DID. OR US-6077782-\$.DID. OR US-6194024-\$.DID.	USPAT	ÓR .	OFF	2005/02/02 22:29
S20 0	3	"6657306".pn.	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 21:31
S20 1	0	S200 and peripitat\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2005/07/29 21:32
S20 2	0	S200 and percipitat\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON ·	2005/07/29 21:32
S20 3	0	S200 and percipit\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 21:32
S20 4	1	S200 and precipit\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR ·	ON	2005/07/29 21:49

			110 505::-	00	011	2005/07/20 51 15
S20 5	1849	(( (cu or copper) or (ni or nickel) or (au or gold)) near4 paste) same (particle or grain)	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 21:49
S20 6	1144216	powder\$4	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2005/07/29 21:47
S20 7	484404	precipit\$6	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 21:49
S20 8	11419	((cu or copper) or (ni or nickel) or (au or gold)) near4 paste	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 21:51
S20 9	105	S208 same S207	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 21:51
S21 0	12303	((cu or copper) or (ni or nickel) or (au or gold) or (ti or titanium)) near4 paste	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 21:51
S21 1	131	S210 same S207	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 21:51
S21 2	67	S211 and (@ad < "19980601")	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2005/07/29 21:53
S21 3	1069567	throughhole or through adj hole or via adj hole or plug or damascene	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 21:53
S21 4	10	S212 and S213	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR .	ON	2005/07/29 22:11

S21 5	1188917	solvent .	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON .	2005/07/29 22:11
S21 6	7	S212 and S213 and S215	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 22:14
S21 7	1933474	resin	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 22:14
S21 8	7	S212 and S213 and S215 and S217	US-PGPUB; USPAT; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/29 22:14